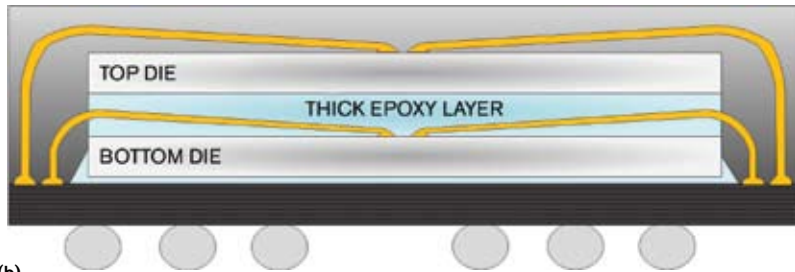




(a)



(b)

Figure 8 One version of die-stack-packaging technology has an interposer (a); another version does not (b).